



**Advanced Power
Electronics Corp.**

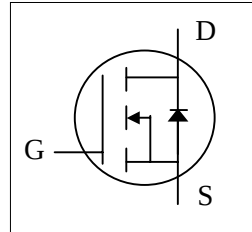
AP05N50P

RoHS-compliant Product

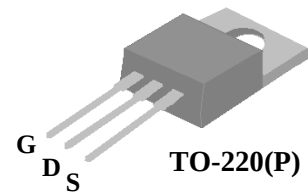
N-CHANNEL ENHANCEMENT MODE

POWER MOSFET

- ▼ 100% Avalanche Test
- ▼ Fast Switching Characteristic
- ▼ Simple Drive Requirement



BV_{DSS}	500V
$R_{DS(ON)}$	1.4 Ω
I_D	5.0A



Description

The AP05N50 provide high blocking voltage to overcome voltage surge and sag in the toughest power system with the best combination of fast switching, ruggedized design and cost-effectiveness.

The TO-220 and package is universally preferred for all commercial-industrial applications. The good thermal performance and low package cost of the TO-220 Contribute to its wide industry application.

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	500	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	5.0	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	2.8	A
I_{DM}	Pulsed Drain Current ¹	18	A
$P_D @ T_C = 25^\circ C$	Total Power Dissipation	73.5	W
	Linear Derating Factor	0.59	W/ $^\circ C$
E_{AS}	Single Pulse Avalanche Energy ²	45	mJ
I_{AR}	Avalanche Current	3	A
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$

Thermal Data

Symbol	Parameter	Value	Unit
R_{thj-c}	Thermal Resistance Junction-case Max.	1.7	$^\circ C/W$
R_{thj-a}	Thermal Resistance Junction-ambient Max.	62	$^\circ C/W$


Electrical Characteristics@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =1mA	500	-	-	V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =2.7A	-	-	1.4	Ω
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	2	-	4	V
g _{fs}	Forward Transconductance	V _{DS} =10V, I _D =2.7A	-	2.4	-	S
I _{DSS}	Drain-Source Leakage Current (T _j =25°C)	V _{DS} =500V, V _{GS} =0V	-	-	25	uA
	Drain-Source Leakage Current (T _j =125°C)	V _{DS} =400V, V _{GS} =0V	-	-	250	uA
I _{GSS}	Gate-Source Leakage	V _{GS} =±20V	-	-	±100	nA
Q _g	Total Gate Charge ³	I _D =3.1A	-	19	30	nC
Q _{gs}	Gate-Source Charge	V _{DS} =400V	-	4.6	-	nC
Q _{gd}	Gate-Drain ("Miller") Charge	V _{GS} =10V	-	6.3	-	nC
t _{d(on)}	Turn-on Delay Time ³	V _{DD} =250V	-	11	-	ns
t _r	Rise Time	I _D =3.1A	-	8	-	ns
t _{d(off)}	Turn-off Delay Time	R _G =12Ω, V _{GS} =10V	-	32	-	ns
t _f	Fall Time	R _D =80.6Ω	-	10	-	ns
C _{iss}	Input Capacitance	V _{GS} =0V	-	985	1580	pF
C _{oss}	Output Capacitance	V _{DS} =25V	-	85	-	pF
C _{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	3.3	-	pF
R _g	Gate Resistance	f=1.0MHz	-	2.5	3.8	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V _{SD}	Forward On Voltage ³	T _j =25°C, I _S =4.5A, V _{GS} =0V	-	-	1.5	V
t _{rr}	Reverse Recovery Time ³	I _S =3.1A, V _{GS} =0V,	-	300	-	ns
Q _{rr}	Reverse Recovery Charge	dI/dt=100A/μs	-	2.6	-	uC

Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Starting T_j=25°C, V_{DD}=50V, L=10mH, R_G=25Ω, I_{AS}=3A.
- 3.Pulse test

THIS PRODUCT IS ELECTROSTATIC SENSITIVE, PLEASE HANDLE WITH CAUTION.

THIS PRODUCT HAS BEEN QUALIFIED FOR USE IN CONSUMER APPLICATIONS. APPLICATIONS OR USE IN LIFE SUPPORT OR OTHER SIMILAR MISSION-CRITICAL DEVICES OR SYSTEMS ARE NOT AUTHORIZED.

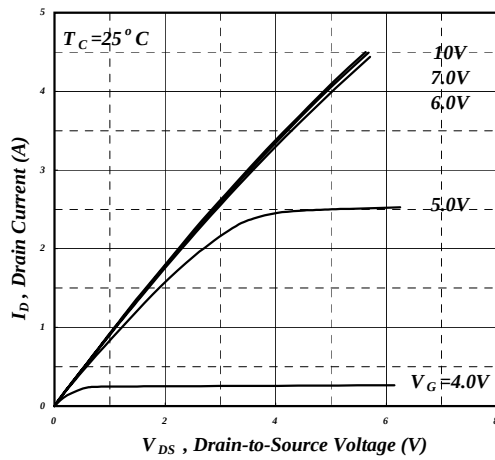


Fig 1. Typical Output Characteristics

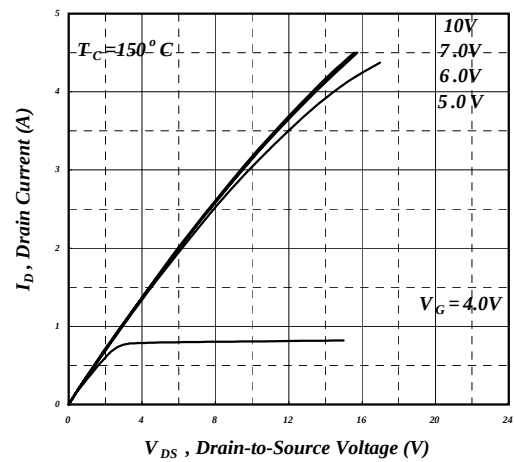


Fig 2. Typical Output Characteristics

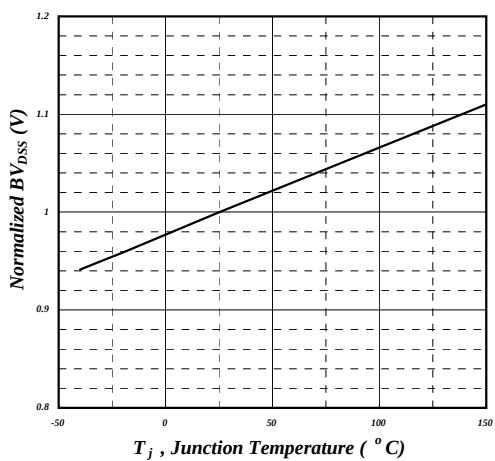


Fig 3. Normalized BV_{DSS} v.s. Junction Temperature

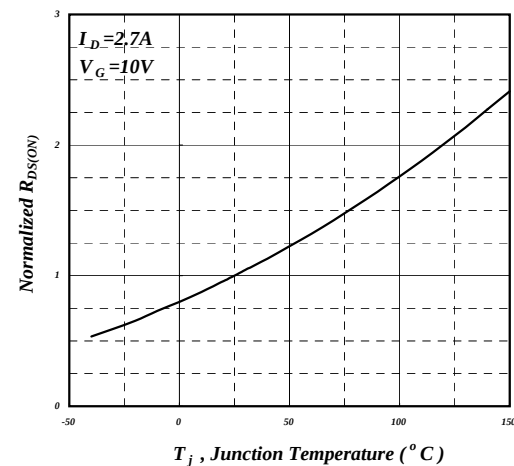


Fig 4. Normalized On-Resistance v.s. Junction Temperature

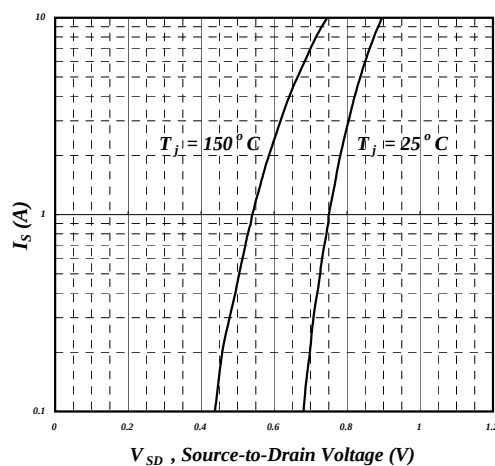


Fig 5. Forward Characteristic of Reverse Diode

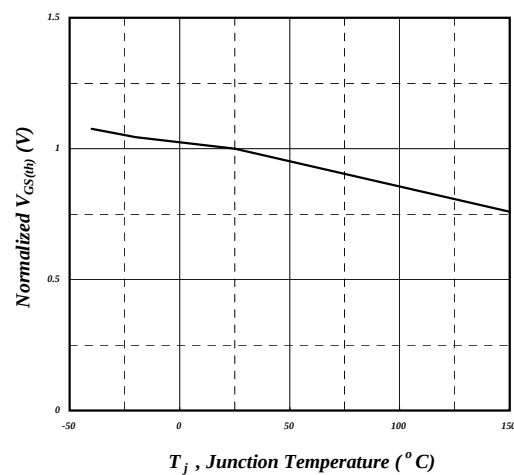


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

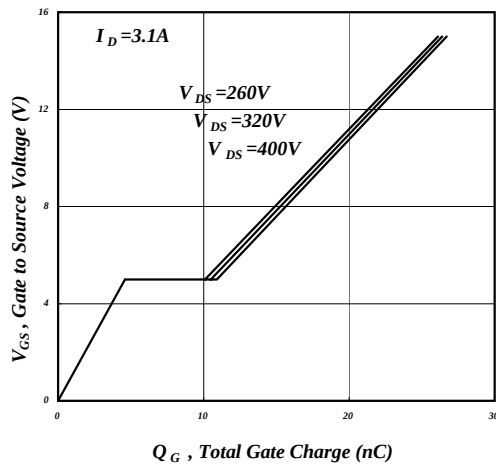


Fig 7. Gate Charge Characteristics

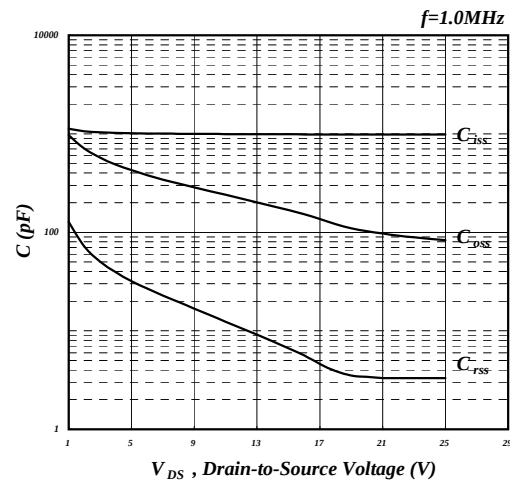


Fig 8. Typical Capacitance Characteristics

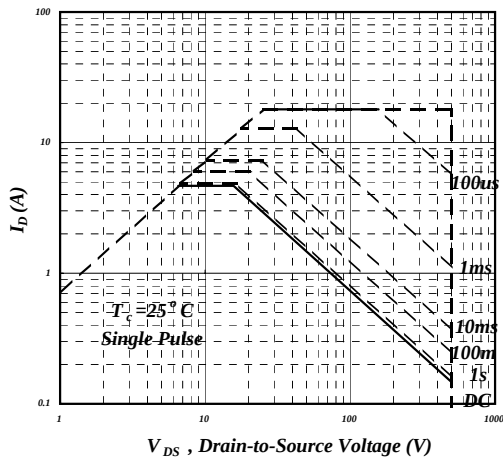


Fig 9. Maximum Safe Operating Area

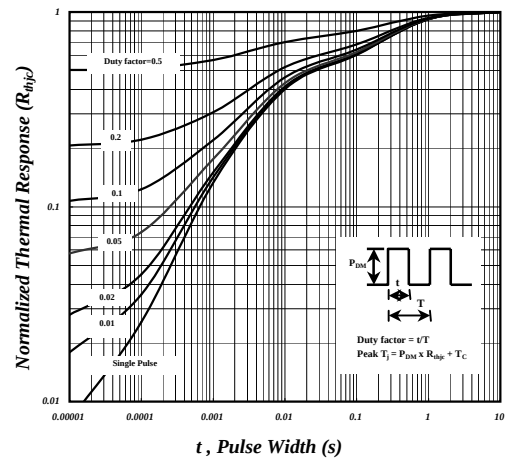


Fig 10. Effective Transient Thermal Impedance

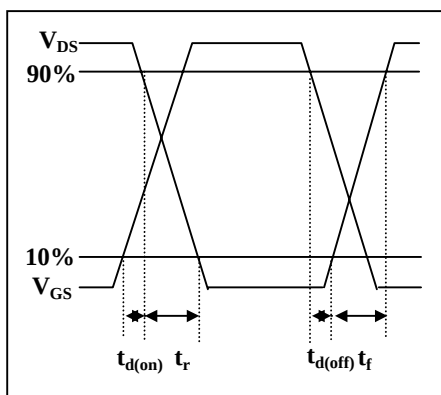


Fig 11. Switching Time Waveform

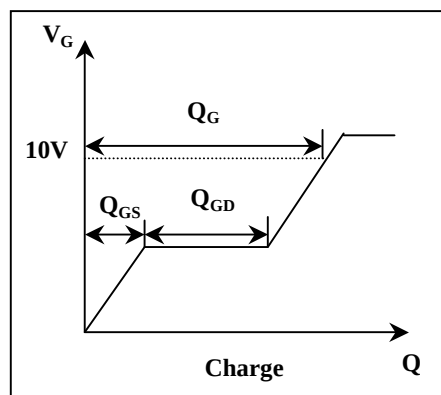


Fig 12. Gate Charge Waveform